

BB173 VHF variable capacitance diode Rev. 1 — 25 March 2013

Product data sheet

1. Product profile

1.1 General description

The BB173 is a variable capacitance diode, fabricated in planar technology, and encapsulated in the SOD523 (SC-79) ultra small SMD plastic package.

1.2 Features and benefits

- Excellent linearity
- Ultra small SMD plastic package
- $C_{d(28V)} = 2.6 \text{ pF}; C_{d(1V)} \text{ to } C_{d(28V)} \text{ ratio} = 15$
- Very low series resistance

1.3 Applications

Voltage Controlled Oscillators (VCO)

2. Pinning information

Pin	Description	Simplified outline	Symbol
1	cathode	[1]	
2	anode 1 2	\downarrow	
			sym008

[1] The marking bar indicates the cathode.

3. Ordering information

Table 2.Ordering information

Type number	Package			
	Name	Description	Version	
BB173	SC-79	plastic surface-mounted package; 2 leads	SOD523	



4. Marking

Table 3. Marking	
Type number	Marking code
BB173	CE

5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _R	reverse voltage		-	32	V
		peak value in series with a 10 $k\Omega$ resistor	-	35	V
I _F	forward current		-	20	mA
T _{stg}	storage temperature		-55	+150	°C
Tj	junction temperature		-55	+125	°C

6. Characteristics

Table 5.Characteristics

 $T_i = 25 \ ^{\circ}C$ unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _R	reverse current	V _R = 30 V	[1]	-	-	10	nA
		$V_R = 30 \text{ V}; \text{ T}_j = 85 ^{\circ}\text{C}$	[1]	-	-	200	nA
r _s	diode series resistance	$f = 100 \text{ MHz}; C_d = 30 \text{ pF}$		-	0.65	0.8	Ω
C _d	diode capacitance	f = 1 MHz	[2]				
		V _R = 1 V		34.65	-	42.35	pF
		V _R = 28 V		2.361	2.6	2.754	pF
$C_{d(1V)}/C_{d(2V)}$	diode capacitance ratio (1 V to 2 V)	f = 1 MHz		-	1.3	-	
$C_{d(1V)}/C_{d(28V)}$	diode capacitance ratio (1 V to 28 V)	f = 1 MHz		13.5	15	-	
$C_{d(25V)}/C_{d(28V)}$	diode capacitance ratio (25 V to 28 V)	f = 1 MHz		-	1.08	-	

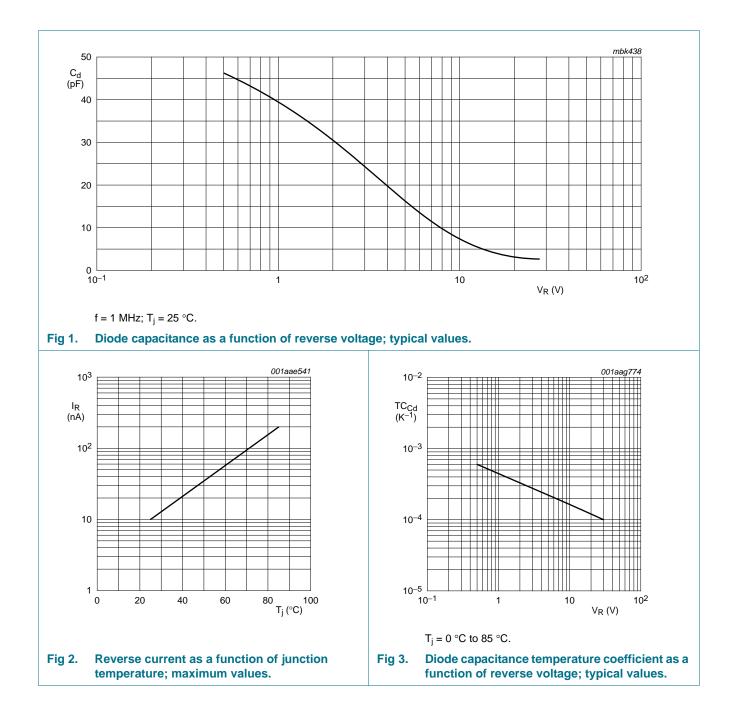
[1] See Figure 2.

[2] See <u>Figure 1</u> and <u>Figure 3</u>.

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7. **Package outline**

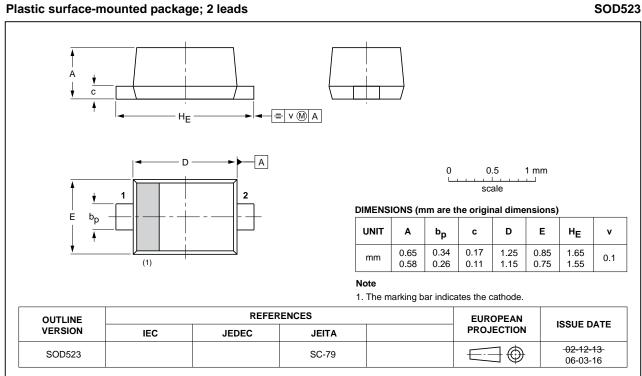


Fig 4. Package outline SOD523 (SC-79) **SOD523**

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8. Abbreviations

Table 6.	Abbreviations
Acronym	Description
SMD	Surface Mounted Device
VHF	Very High Frequency

9. Revision history

Table 7. Revision his	tory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
BB173 v.1	20130325	Product data sheet	-	-

10. Legal information

10.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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Date of release: 25 March 2013 Document identifier: BB173

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